440055-3 ~ ACTIVE

TE Internal #: 440055-3 PCB Mount Header, Right Angle, Wire-to-Board, 3 Position, .079 in [2 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, Natural

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Connectors > PCB Connectors > PCB Headers & Receptacles > AMP HPI 2.0MM HEADERS



Connector System: Wire-to-Board

Number of Positions: 3

Number of Rows: 1

Centerline (Pitch): 2 mm [.079 in]

PCB Mount Orientation: Right Angle

All AMP HPI 2.0MM HEADERS (212)

Features

Product Type Features

Connector System

Header Type

Wire-to-Board

Partially Shrouded

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Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Bright
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.5 mm[.02 in]
Termination Post & Tail Length	3.4 mm[.134 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Polarization
Mating Retention	Without
PCB Mount Retention Type	Kinked Tines
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	With
Housing Features	
Housing Material	Nylon 66 GF
Centerline (Pitch)	2 mm[.079 in]
Dimensions	
Connector Length	8 mm[.314 in]
Connector Height	4.95 mm[.195 in]
Connector Width	7.7 mm[.303 in]
PCB Thickness (Recommended)	1 – 1.6 mm[.039 – .063 in]
Usage Conditions	
Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	

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PCB Mount Header, Right Angle, Wire-to-Board, 3 Position, .079 in [2 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, Natural



UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	250
Packaging Type	Bag
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUL 2021 (219) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Header, Right Angle, Wire-to-Board, 3 Position, .079 in [2 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, Natural





AMP HPI 2.0MM RECEPTACLE HOUSINGS

Customers Also Bought





RQ 1206 255K 0.1% 10PPM 5K RL



Documents

Product Drawings 2.0MM,HDR,3POS,R/A

English

2.0MM,HDR,3POS,R/A

English

CAD Files

3D PDF

3D

PCB Mount Header, Right Angle, Wire-to-Board, 3 Position, .079 in [2 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, Natural



Customer View Model

ENG_CVM_CVM_440055-3_B3.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_440055-3_B3.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_440055-3_B3.3d_stp.zip

English

By downloading the CAD file I accept and agree to the $\ensuremath{\mathsf{Terms}}$ and $\ensuremath{\mathsf{Conditions}}$ of use.

Datasheets & Catalog Pages HPI Connectors QRG

English

Product Specifications

Application Specification

English

Product Environmental Compliance MD_440055-3_041920181321_dmtec

English

MD_440055-3_041920181321_dmtec

English

Agency Approvals

UL Report

English